

31PE Docket No.: P2001,0178

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By: *Werner Stemer*

Date: August 11, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/661,340 Confirmation No: 8041
Applicant : Albert Birner et al.
Filed : September 12, 2003
Title : Configuration and Method for Making Contact with the Back Surface of a Semiconductor Substrate
Art Unit : 2818
Examiner : David Vu

Docket No. : P2001,0178
Customer No. : 24131

R E S P O N S E

Hon. Commissioner for Patents

Sir:

Responsive to the Office Action dated July 27, 2004, the following remarks are made:

In deference to the restriction requirement on pages 2 and 3 of the above-identified Office Action, applicants elect group I, claims 1-4, for prosecution at this time.

Applicants request a rejoinder under MPEP §821.04.

In view of the foregoing, the early issuance of an Action on the merits of claims 1-4 is solicited.

Respectfully submitted,

Werner Stemer

For Applicants

WERNER H. STEMER
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Date: August 11, 2004

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